

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Toshitsugu YAJIMA</td><td>05/10/2007</td></tr><tr><td>Toshiyuki KAMADA</td><td>05/10/2007</td></tr></tbody></table>	Name	Execution Date	Toshitsugu YAJIMA	05/10/2007	Toshiyuki KAMADA	05/10/2007	
Name	Execution Date						
Toshitsugu YAJIMA	05/10/2007						
Toshiyuki KAMADA	05/10/2007						
RECEIVING PARTY DATA							
Name:	SHIN-ETSU POLYMER CO., LTD.						
Street Address:	3-5 Nihonbashi-Honcho 4-chome, Chuo-ku						
City:	Tokyo						
State/Country:	JAPAN						
Postal Code:	103-0023						
PROPERTY NUMBERS Total: 1							
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11756991</td></tr></tbody></table>	Property Type	Number	Application Number:	11756991			
Property Type	Number						
Application Number:	11756991						
CORRESPONDENCE DATA							
Fax Number:	(212)575-0671						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
Phone:	2127929200						
Email:	dxo@cll.com						
Correspondent Name:	Mark Montague						
Address Line 1:	1133 Avenue of the America						
Address Line 2:	Cowan, Liebowitz & Latman, P.C.						
Address Line 4:	New York, NEW YORK 10036						
ATTORNEY DOCKET NUMBER:	24530-020						
NAME OF SUBMITTER:	Mark Montague						
Total Attachments: 1 source=24530020Assignment#page1.tif							

OP \$40.00 11756991

500288083

PATENT
REEL: 019370 FRAME: 0577

ASSIGNMENT

FOR ONE DOLLAR (\$1.00) and other valuable and sufficient consideration, the receipt of which is hereby acknowledged, we

Toshitsugu YAJIMA and Toshiyuki KAMADA

being the inventors of certain improvements and invention in

WAFER STORAGE CONTAINER

for which a United States Non-Provisional Patent Application is to be filed, and which claims priority to Japanese application number 2006-158372, filed on June 7, 2006, hereby assign unto

SHIN-ETSU POLYMER CO., LTD.

a company of Japan having a principal place of business at: 3-5, Nihonbashi-Honcho 4-chome, Chuo-ku, 103-0023, Tokyo, Japan, its successors and assigns, the entire right, title and interest in and to said improvements, inventions and said United States Patent Application, and all divisions, continuations, reissues, and extensions thereof; and to all Letters Patent that may be granted thereon; said improvements, inventions and Letters Patent to be held and enjoyed by said Assignee for its own use and behoove and for the use and behoove of its successors and assigns, to the full end of the term for which said Letters Patent or other rights of protection may be granted, as fully and as entirely as the same would have been held and enjoyed by us had this assignment and sale not been made.

AND WE COVENANT, AGREE AND WARRANT that we have a full and unencumbered title to the invention hereby assigned, and we further covenant and agree that we will, at any time upon request, without further compensation, execute and deliver any and all papers or instruments that in the opinion of the Assignee may be necessary or desirable to secure said Assignee the full enjoyment of the rights and properties herein conveyed or intended to be conveyed.

IN WITNESS WHEREOF, We have hereunto set our hand and seal:

Date: May 10, 2007

Toshitsugu Yajima.

Toshitsugu YAJIMA

Date: May 11, 2007

Noboru Naka Fuji

Witness

Date: May 10, 2007

Toshiyuki Kamada

Toshiyuki KAMADA

Date: May 11, 2007

Noboru Naka Fuji.

Witness